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| <b>Search Notes</b><br><br> | <b>Application/Control No.</b><br><br>10663776 | <b>Applicant(s)/Patent Under Reexamination</b><br><br>YI, BYUNG K. |
|  | <b>Examiner</b><br><br>Nhon T Diep             | <b>Art Unit</b><br><br>2621  |

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|-----------------|-----------------|-------------|-----------------|
| <b>SEARCHED</b> |                 |             |                 |
| <b>Class</b>    | <b>Subclass</b> | <b>Date</b> | <b>Examiner</b> |
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| <b>SEARCH NOTES</b> |             |                 |
| <b>Search Notes</b> | <b>Date</b> | <b>Examiner</b> |
| Consulted with Rao  | 7/31/2008   | ND              |

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| <b>INTERFERENCE SEARCH</b> |                 |             |                 |
| <b>Class</b>               | <b>Subclass</b> | <b>Date</b> | <b>Examiner</b> |
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